

Design, fabrication, and testing of microfluidic devices for biochemical analysis

Isabel Castillo
Vassar College

REU PI: Dr. William L. Wilson

REU Mentors: Dr. Ling Xie

Dr. Arthur McClellan

Hao-Yu Lin

REU 2017

Outline

- Introduction
- Design
- Fabrication

Benefits of Microfluidics Devices

- Improves the precision of experiments
- Run multiple analyses simultaneously
- Can be applied to nanotechnology

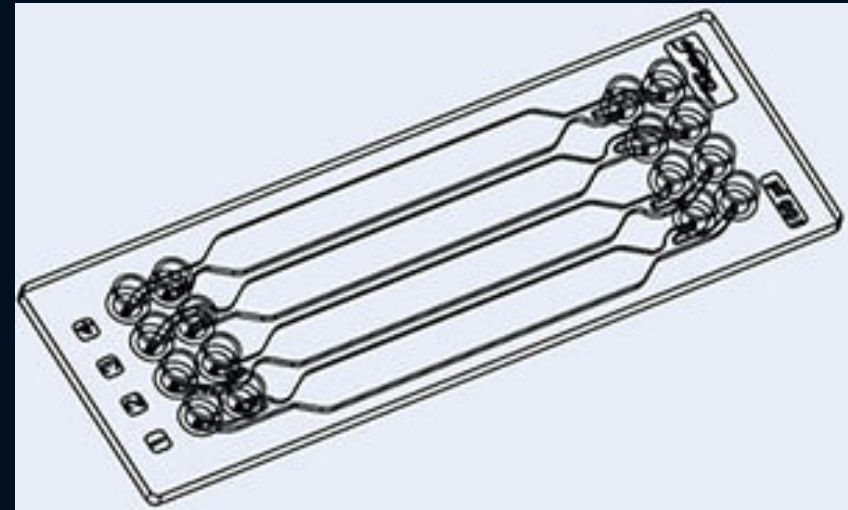
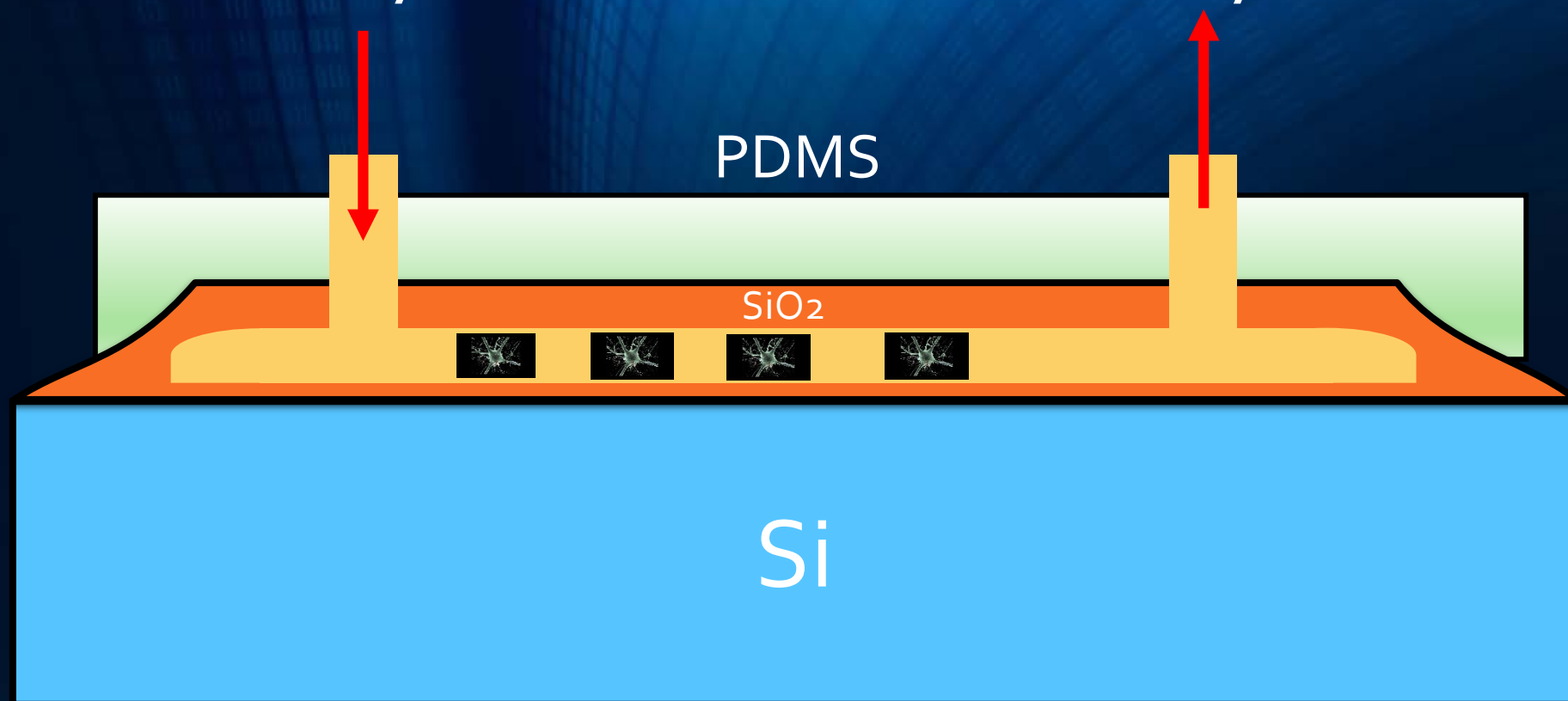


Figure 1 : Example of a microfluidic chip with channels thinner than 1 mm

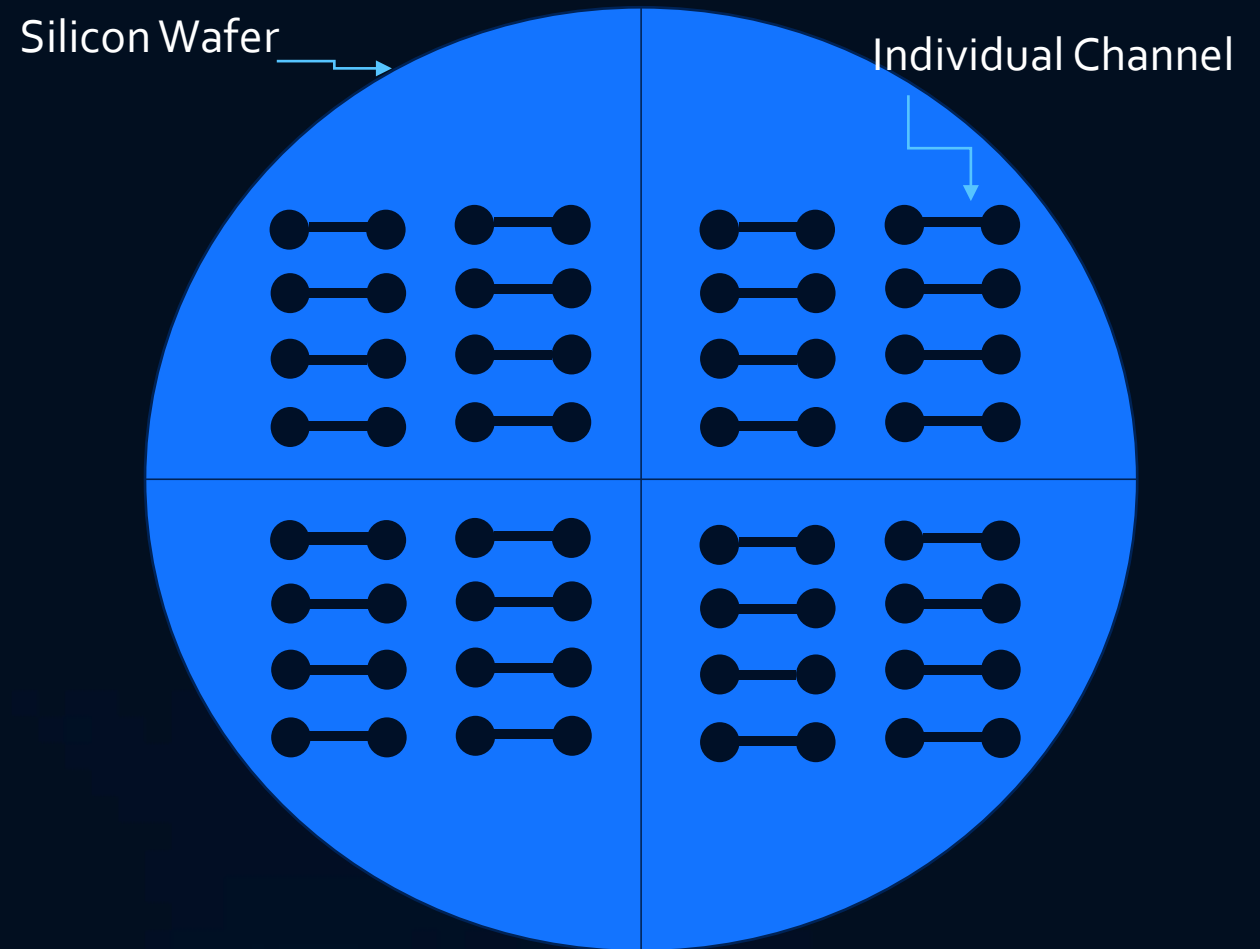
Final Product : Microfluidic Device

- Ready for Biochemical Analysis

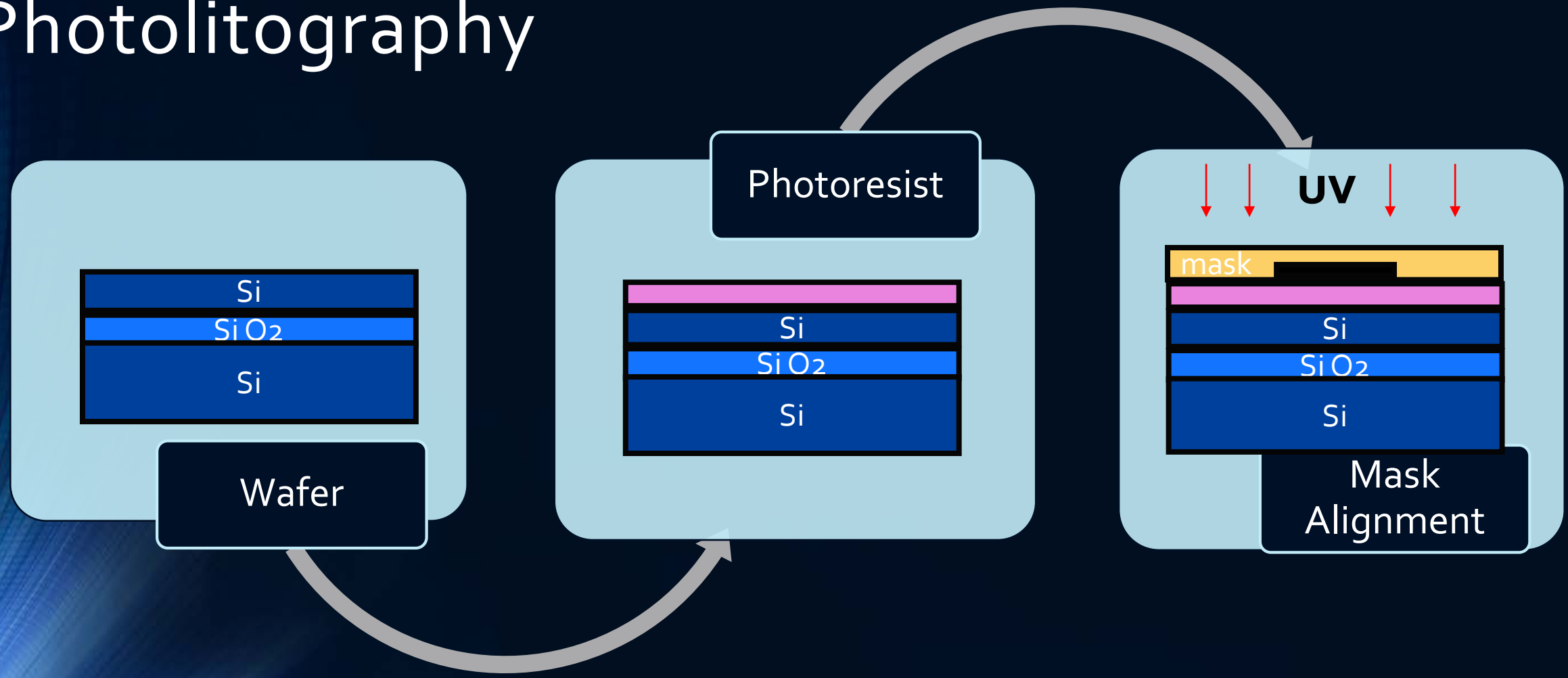


Dimensions

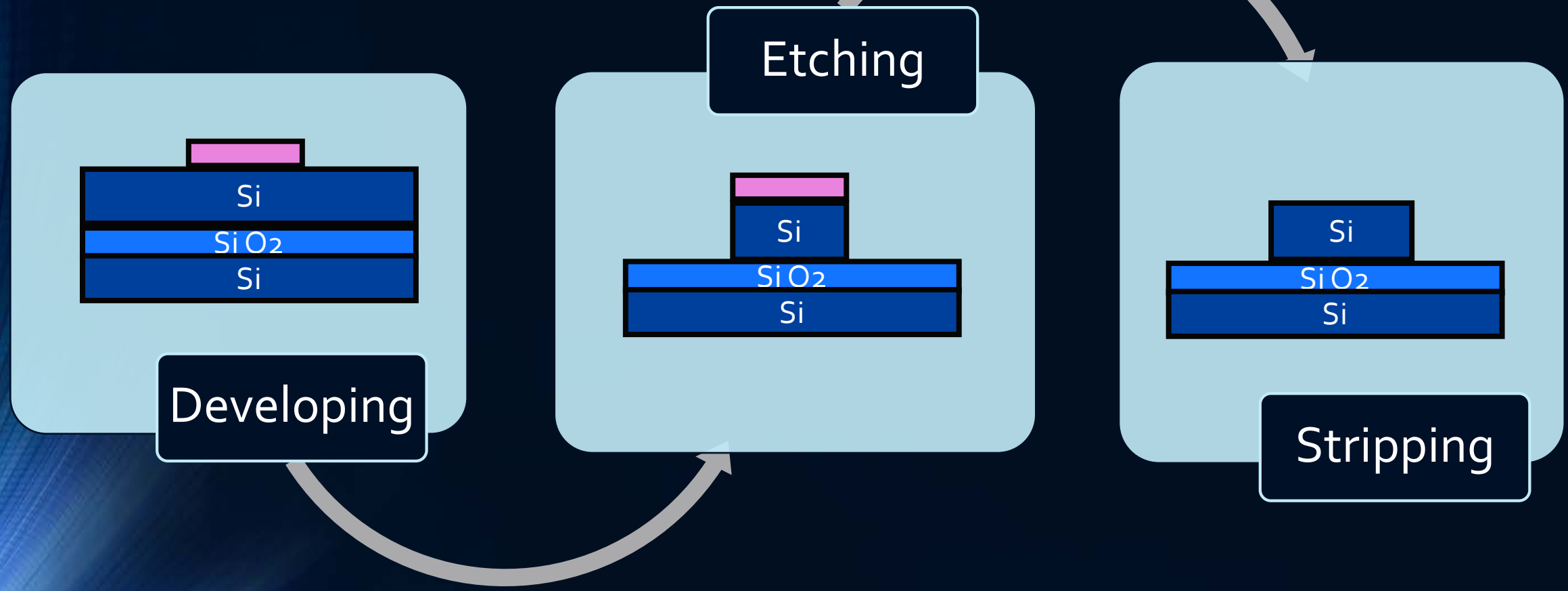
- Length : 10 mm
- Side : 10mm
- Between: 15mm
- Diameter: 1mm
- $W_1 = 50 \mu\text{m}$
- $W_2 = 100 \mu\text{m}$



Photolithography



Photolithography



Thermal Oxidation : Conditions

Purpose:

To produce a thin layer of oxide on the surface of a wafer

Temperature : 1100°C

Time: 8hrs

- Furnace at O_2 Flows in $\text{---}\rightarrow\text{SiO}_2$
- $2\mu\text{m}$ of SiO_2

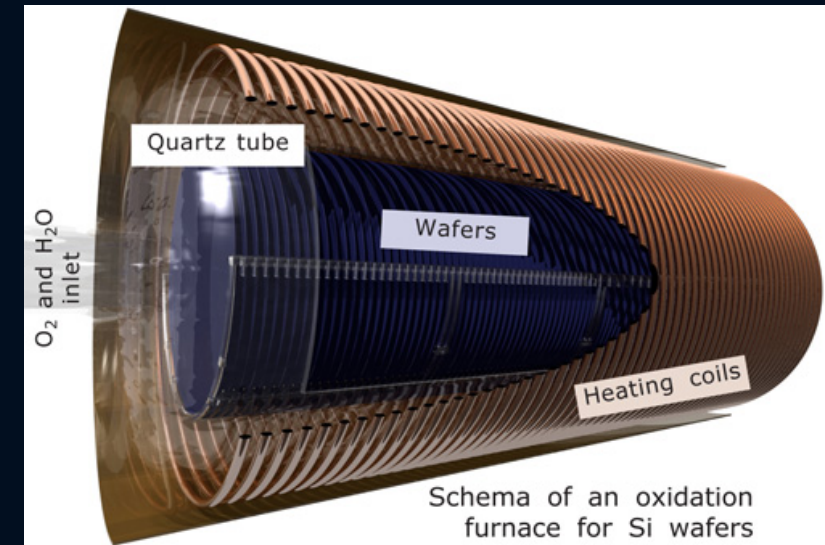


Figure 2 : Example of the inside of a furnace.

Thermal Oxidation: Cross Sectional View

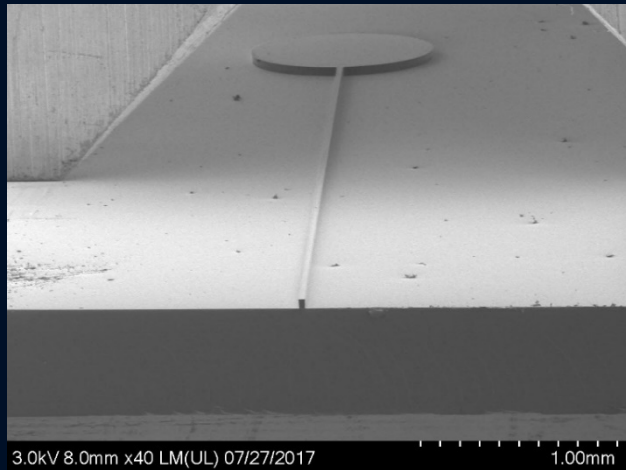


Figure 4: Cross sectional view of a 50 μ m channel.

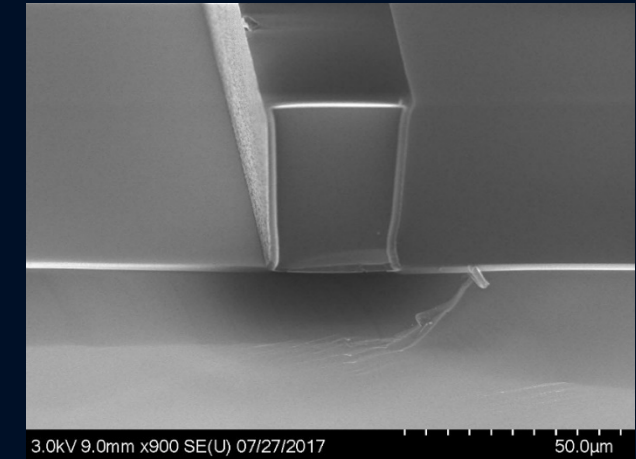


Figure 4: SEM image of a sample device revealed a 90° between the Si layer and the wall of the device.



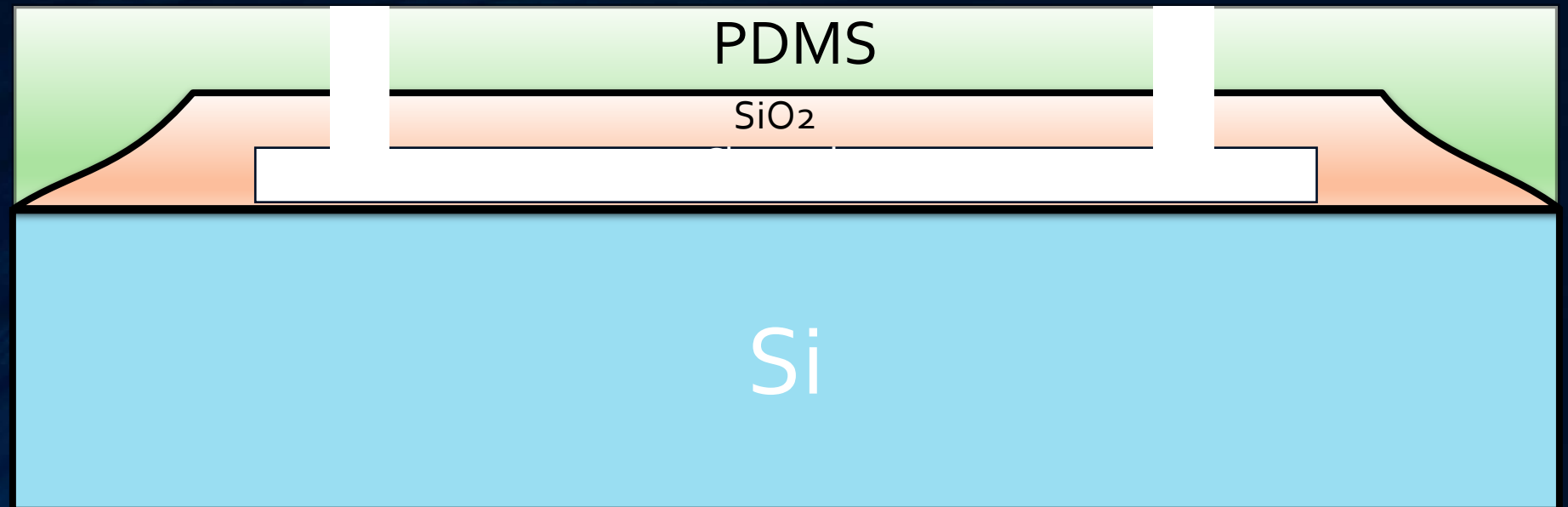
Soft Lithography

- Coat the sample with PDMS
- Spin Cycle
- Holes Punched
- BOE Etch to remove the SiO₂



XeF₂ Etch

- Remove Si Inside the channel



XeF₂ Etch : Results

- Conditions

60 cycles

40 s pulses time

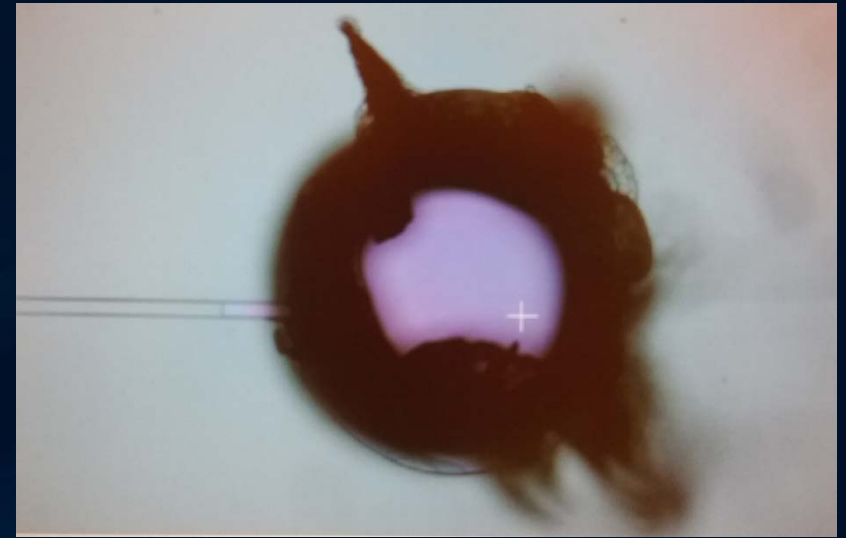


Figure 4: XeF₂ etch sample

Final Product : Microfluidic Device

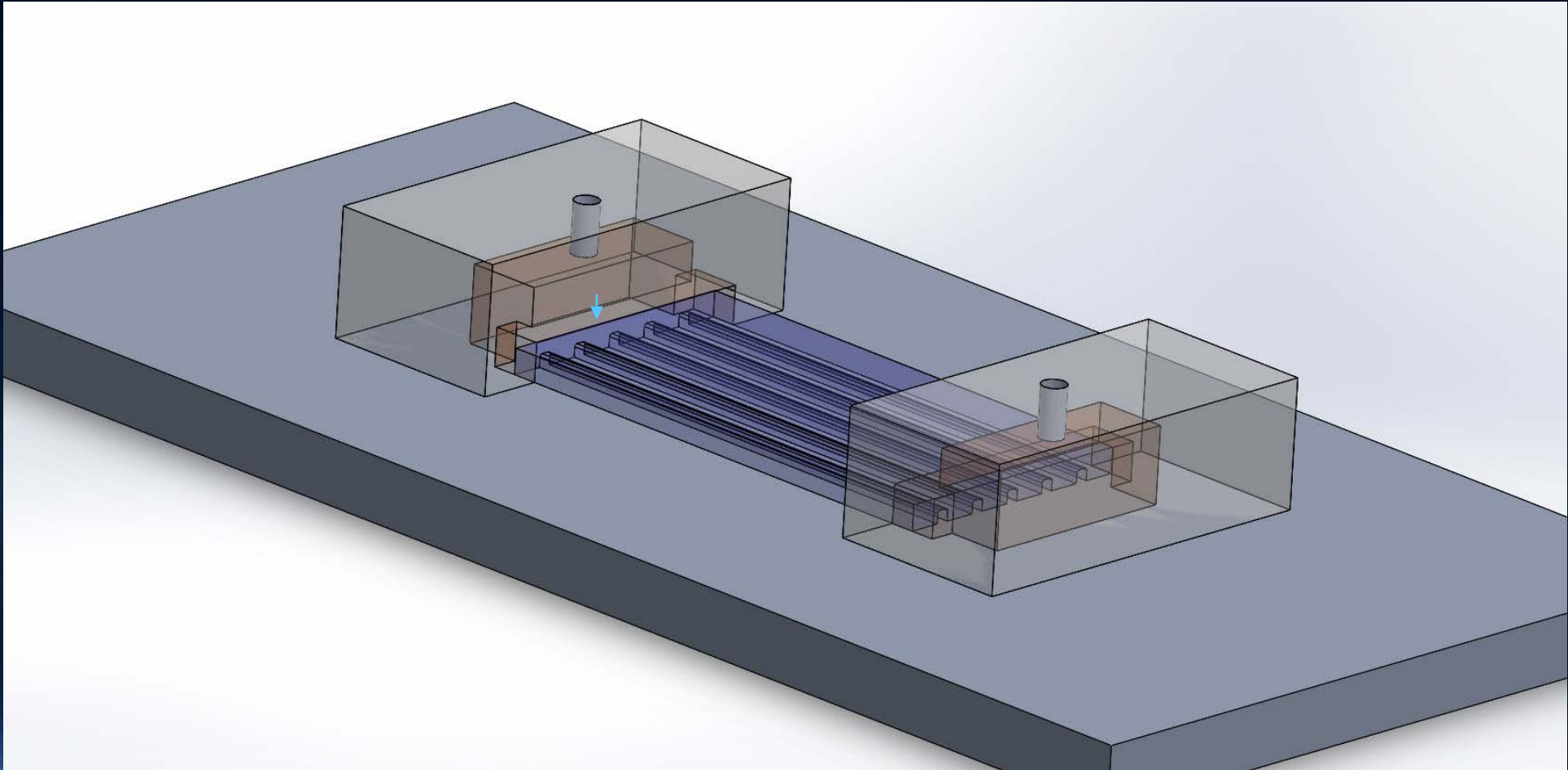
- Ready for Biochemical Analysis



Further Work:

- ALD Deposition
- Varying Ni and XeF₂ ratios

Nanotechnology



Acknowledgements:

Dr. William Wilson
Dr. Arthur McClelland
Mac Hathaway
Sandra Nakasone
Ameha Gebreyohannes
Kathryn Hollar

Dr. Ling Xie
Greg Lin
Malcolm Tse
John Tsakirgis
Kenlin Huang
Sara Wenzel

